MSKSEMI 美森科













ESD

T\

TSS

MOV

GDT

PLED

NX7002AK-MS

Product specification





Features

- 60V,0.3A, RDS(ON) =2.2Ω@VGS=10V
- Improved dv/dt capability
- Fast switching
- Green Device Available
- G-S ESD Protection Diode Embedded
- ESD protected up to 2KV

BVDSS	RDSON	ID
60V	2.2Ω	0.3A

Reference News

PACKAGE OUTLINE	Pin Configuration	Marking
G S S S S S S S S S S S S S S S S S S S	G°X	.702°

Absolute Maximum Ratings (TA=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units
Vos	Drain- Source Voltage	60	V
Vgs	Gate- Sou₁ce Voltage	±20	V
I _D	Drain Current – Continuous (T _C =25℃)	0.3	А
July 10	Drain Current – Continuous (Tc=100℃)		А
Ідм	Drain Current – Pulsed ¹	0.8	А
Pp	Power Dissipation (T _C =25 ℃)	0.35	W
	Power Dissipation – Derate above 25℃	0.003	W/°C
Тѕтс	Storage Temperature Range	-50 to 150	°C
TJ	Operating Junction Temperature Range	-50 to 150	°C



Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
Reja	Thermal Resistance Junction to ambient		357	°c/W

Electrical Characteristics(TJ=25 °C , unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain- Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60			V
1	Drain- Source Leakage Current	V _{DS} =60V , V _{GS} =0V , T _J =25℃			1	ŭΑ
IDSS	1	V _{DS} =48V , V _{GS} =0V , T _J =125℃			10	uА
Igss	Gate- Source Leakage Current	V _{GS} ±20V , V _{DS} =0V			±10	uА

On Characteristics

Rps/ONN Static Drain-Source On-Resistance		V _{GS} =10V , I _D =0.3A		2.2	2.8	Ω
Rds(on)	Static Drain-Source On-Nesistance	V _{GS} =4.5V , I _D =0.2A		2 4	3 0	Ω
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	1	1.6	2.5	V
gfs	Forward Transconductance	V _{DS} =10V , I _D =0.3A		0.5	I	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge ^{2, 3}		 3.7	5.6	
Qgs	Gate-Source Charge ² , ³	V_{DS} =30 V , V_{GS} =10 V , I_{D} =1 A	 0.9	1.4	nC
Q_{gd}	Gate-Drain Charge ^{2, 3}		 0.4	0.6	
T _{d(on)}	Turn-On Delay Time ^{2, 3}		 3	6	
Tr	Rise Time ^{2, 3}	V_{DD} =30V , V_{GS} =10V , R_{G} =6 Ω	 5	10	ns
T _{d(off)}	Turn-Off Delay Time ^{2, 3}	I _D =0.2A	 14	27	113
Tf	Fall Time ^{2, 3}		 9	17	
Ciss	Input Capacitance		 25.5	38	
Coss	Output Capacitance	V_{DS} =30 V , V_{GS} =0 V , F =1 MHz	 17	26	pF
Crss	Reverse Transfer Capacitance		 7.8	12	-

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V , Force Current			0.3	Α
Іѕм	Pulsed Source Current	VG-VD-OV, I OICE Cullent			1.2	Α
Vsb	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25℃			1	٧
trr	Reverse Recovery Time	V _{GS} =50V, I _S =1A , dI/dt=100A/μs		3.4		ns
Qrr	Reverse Recovery Charge	T _J =25℃		0.7		nC

Note:

- 1.Repetitive Rating: Pulsed width limited by maximum junction temperature.
- $2\,.$ The data tested by pulsed , pulse width $\leqq 300\,us$, duty cycle $\leqq 2\,\%\,.$
- 3. Essentially independent of operating temperature.

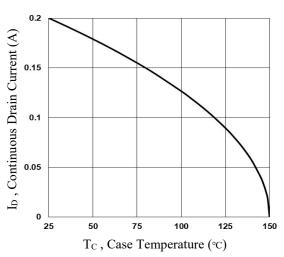


Fig.1 Continuous Drain Current vs. Tc

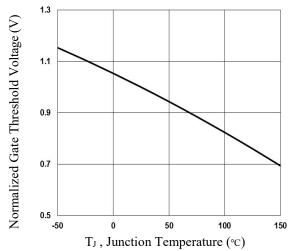


Fig.3 Normalized V_{th} vs. T_J

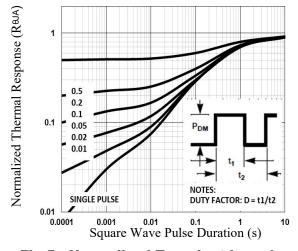


Fig.5 Normalized Transient Impedance

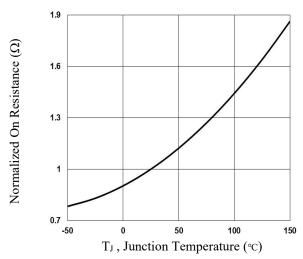


Fig.2 Normalized RDSON vs. T_J

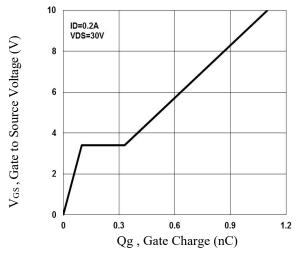


Fig.4 Gate Charge Waveform

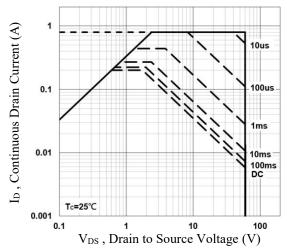
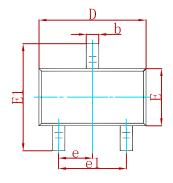
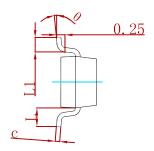


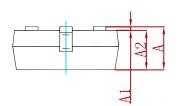
Fig.6 Maximum Safe Operation Area



PACKAGE MECHANICAL DATA

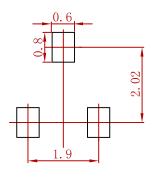






Symbol	Dimensions	Dimensions In Millimeters		s In Inches
Symbol	Min	Max	Min	Max
Α	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
С	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
е	0.950) TYP	0.037	7 TYP
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022	2 REF
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Suggested Pad Layout



Note:

- 1. Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
NX7002AK-MS	SOT-23	3000



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DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 DMC2700UDMQ-7 DMN2080UCB4-7
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DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
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